

ShenZhen JuFei Optoelectronics Co., Ltd.



01.JT.CB320ZA-B

● Customer:

PN: JT.CB320ZA-B

For: IF= 20mA

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Customer confirm	Approved	Checked	Issued

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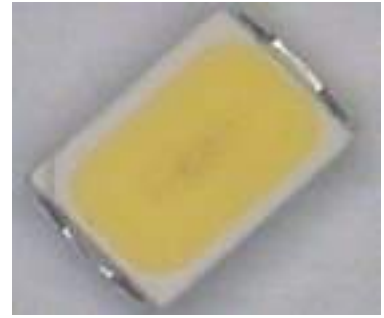
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1、 Features:

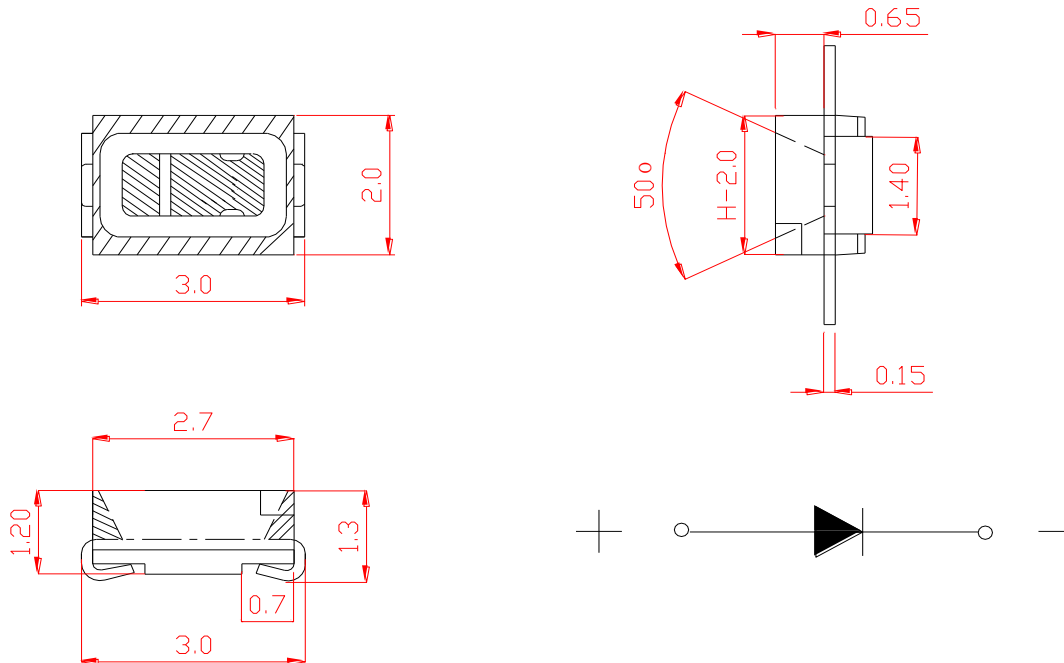
- 1.1 Package: 3.0*2.0*1.2mm (Top view white LED)
- 1.2 Emitted Color: White
- 1.3 Soldering methods: All SMT assembly methods
- 1.4 Comply RoHS standard



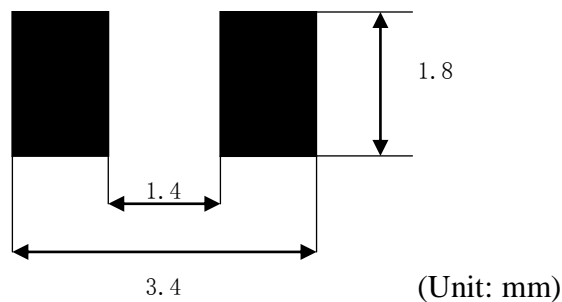
2、 Applications:

- 2.1 Back light for NB, Monitor, LED LCD TV.
- 2.2 Indoor Lighting.

3、 Package Outline Dimension:



[Recommended soldering pad design]



NOTES:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.10 mm unless otherwise specified.
- 3. Gewicht/Approx. weight: 15 ± 0.5 mg

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4、 Absolute Maximum Ratings(Ta=25℃)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	100	mW
Forward Current	I _F	30	mA
Peak Forward Current * 1	I _{FP}	60	mA
Reverse Voltage	V _R	5	V
Soldering Temperature	T _{sol}	Reflow soldering:260℃ for 10sec. Hand soldering:300℃ for 3 sec.	
Operating Temperature	T _{opr}	-35℃~85℃	
Storage Temperature	T _{stg}	-40℃~100℃	

* I_{FP} condition: pulse width ≤0.1msec, duty cycle ≤1/10.

5、 Electrical-optical characteristics(Ta=25℃)

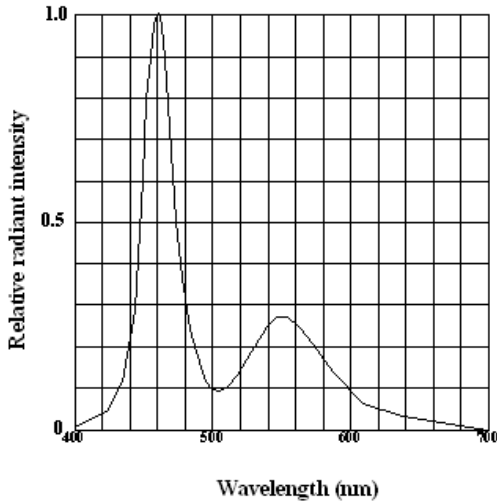
Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward Voltage	V _f	-		3.5	V	I _F =20mA
Luminous Intensity	I _v		2080	-	mcd	
Viewing Angle	2θ _{1/2}	-	120	-	deg	
Reverse Current	I _R	-	0	1	uA	V _R =5V

Note: 1. Tolerance of luminous intensity is ±3%

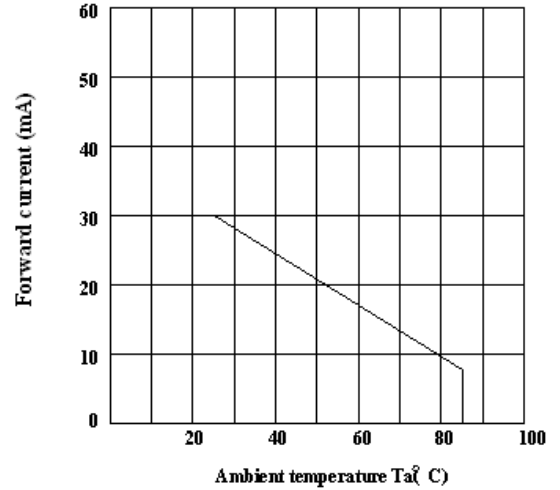
2. Tolerance of forward voltage is ±0.03V

6、Typical Electro-Optical Characteristics Curves

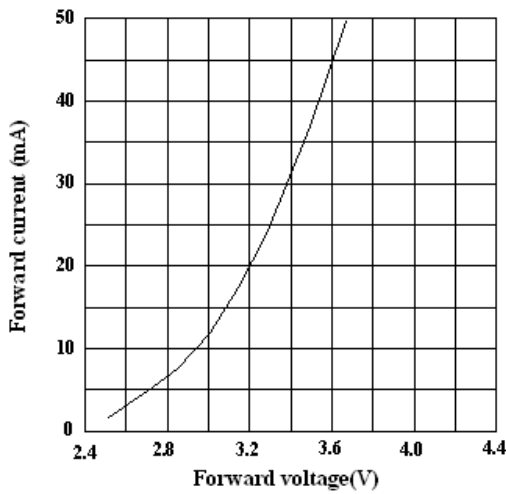
Relative intensity vs. wavelength(Ta=25℃)



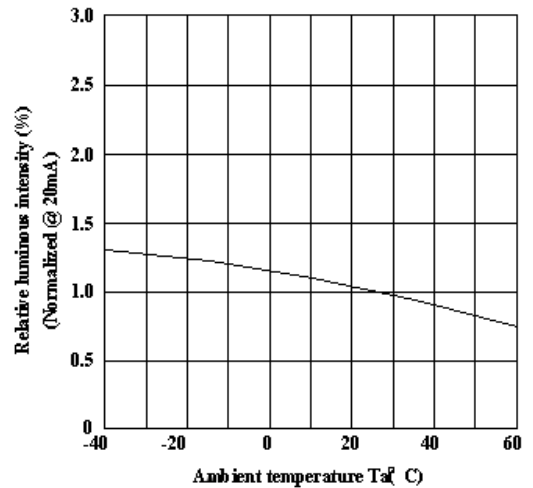
Forward current derating curve vs. ambient temperature



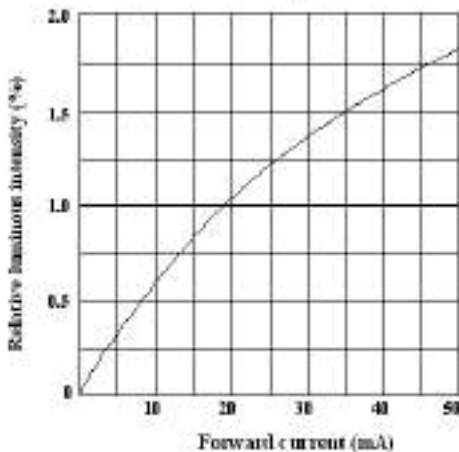
Forward current vs. forward voltage(Ta=25℃)



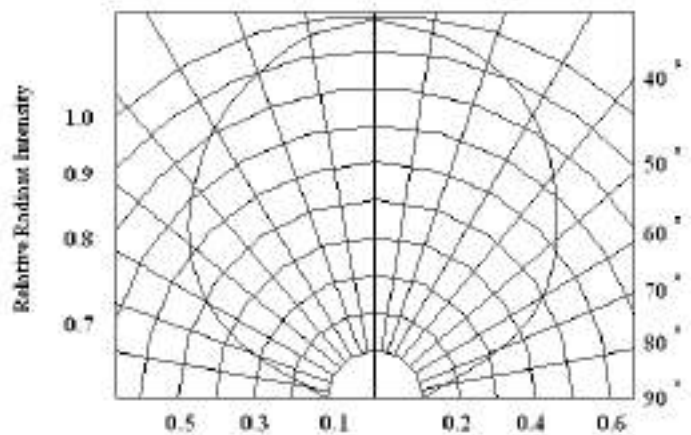
Luminous intensity vs. ambient temperature



Relative luminous intensity vs. forward current

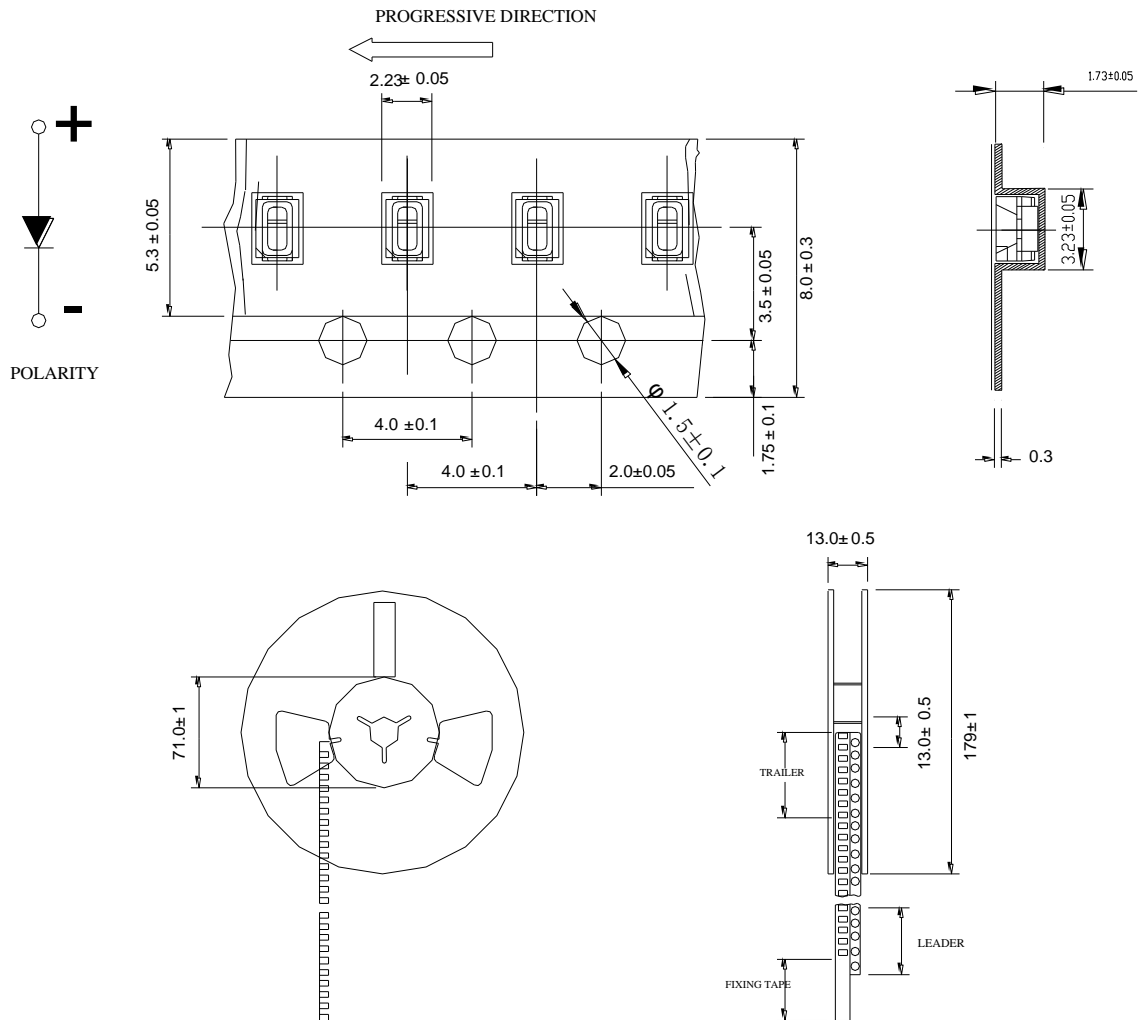


Radiation diagram

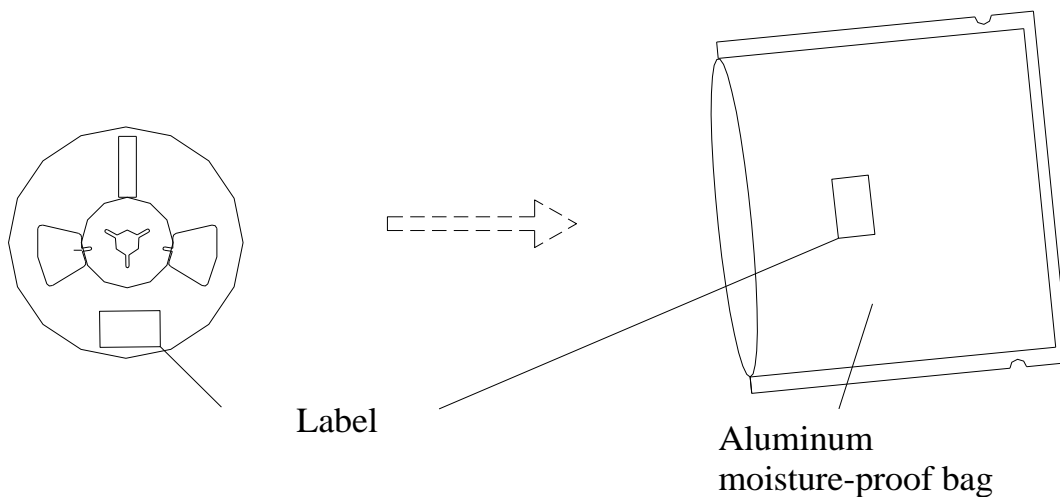


7、Taping specifications (Units: mm)

Loaded quantity: 1000-2000 pcs/reel



8、Package Method:(Unit:mm)

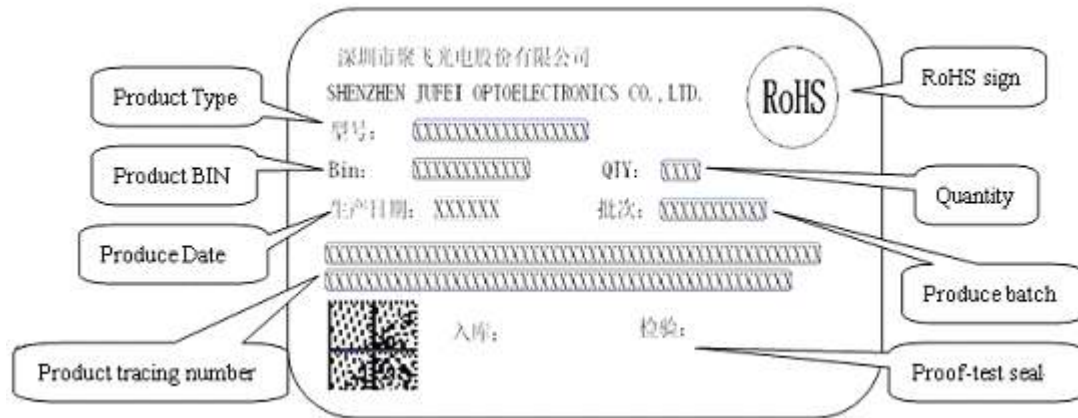


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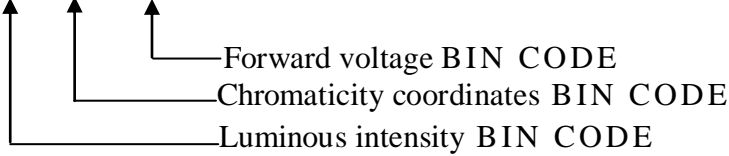


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9、Label description :



BIN description: $\frac{X}{X} / \frac{X}{X} / \frac{X-X}{X-X}$



Such as: BIN: 29/E1/7-1

29 show luminous intensity BIN CODE

E1 show chromaticity coordinates BIN CODE

7-1 show forward voltage BIN CODE

10、BIN range

Luminous intensity (tolerance is $\pm 3\%$ @ $I_f=20mA$):

BIN CODE	Min. (mcd)	Max. (mcd)
27	1850	1920
28	1920	2000
29	2000	2080
30	2080	2160
31	2160	2260
32	2260	2360
33	2360	2460
34	2460	2560
35	2560	2660

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Chromaticity coordinates specifications(tolerance is ± 0.005 @ $I_f=20\text{mA}$) :

BIN	x	y	CCT	BIN	x	y	CCT	BIN	x	y	CCT
A1	0.2514	0.237	19000-27000K	G1	0.271	0.2675	10000-12000K	M1	0.2947	0.3045	7000-8000K
	0.2586	0.248			0.2789	0.2798			0.3017	0.3155	
	0.2623	0.2462			0.2827	0.2779			0.3055	0.3137	
	0.2549	0.2352			0.2748	0.2657			0.2984	0.3027	
A2	0.2549	0.2352		G2	0.2748	0.2657		M2	0.2984	0.3027	
	0.2623	0.2462			0.2827	0.2779			0.3055	0.3137	
	0.2661	0.2443			0.2864	0.276			0.3092	0.3118	
	0.2589	0.2333			0.2785	0.2638			0.3022	0.3008	
C1	0.2586	0.248	15000-19000K	I1	0.2789	0.2798	9000-10000K	O1	0.3017	0.3155	6000-7000K
	0.2646	0.2575			0.287	0.2925			0.3094	0.3275	
	0.2683	0.2557			0.2908	0.2907			0.3132	0.3257	
	0.2623	0.2462			0.2827	0.2779			0.3055	0.3137	
C2	0.2623	0.2462		I2	0.2827	0.2779		O2	0.3055	0.3137	
	0.2683	0.2557			0.2908	0.2907			0.3132	0.3257	
	0.2721	0.2538			0.2945	0.2888			0.3169	0.3238	
	0.2661	0.2443			0.2864	0.27604			0.3092	0.3118	
E1	0.2646	0.2575	12000-15000K	K1	0.2870	0.2925	8000-9000K				
	0.271	0.2675			0.2947	0.3045					
	0.2748	0.2657			0.2984	0.3027					
	0.2683	0.2557			0.2908	0.2907					
E2	0.2683	0.2557		K2	0.2908	0.2907					
	0.2748	0.2657			0.2984	0.3027					
	0.2785	0.2638			0.3022	0.3008					
	0.2721	0.2538			0.2945	0.2888					

BIN	x	y	CCT	BIN	x	y	CCT
Q0	0.2514	0.237	20000-27000K	S	0.271	0.2675	10000-13000K
	0.2441	0.2407			0.2637	0.2712	
	0.2513	0.2517			0.2716	0.2835	
	0.2586	0.248			0.2789	0.2798	
Q	0.2586	0.248	16000-20000K	T	0.2789	0.2798	9000-10000K
	0.2513	0.2517			0.2716	0.2835	
	0.2573	0.2612			0.2797	0.2962	
	0.2646	0.2575			0.287	0.2925	
R	0.2646	0.2575	13000-16000K	U	0.287	0.2925	8000-9000K
	0.2573	0.2612			0.2797	0.2962	
	0.2637	0.2712			0.2874	0.3082	
	0.271	0.2675			0.2947	0.3045	

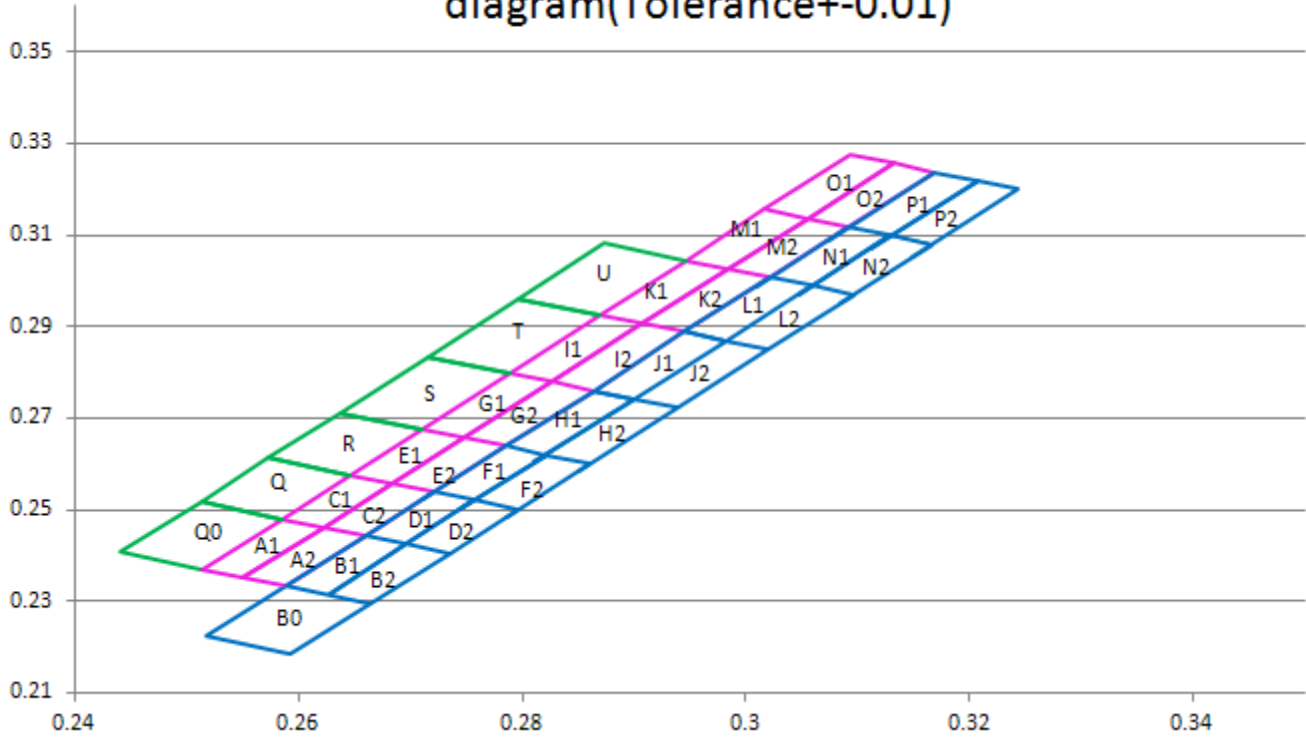
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BIN	x	y	CCT	BIN	x	y	CCT	BIN	x	y	CCT
			25000-43000K	F1	0.2711	0.2521	11500-15000K	L1	0.2983	0.2869	7500-8500K
					0.2785	0.2638			0.2945	0.2888	
					0.2821	0.262			0.3022	0.3008	
					0.2747	0.2503			0.306	0.2989	
B0	0.2589	0.2333		F2	0.2747	0.2503		L2	0.2983	0.2869	
	0.2517	0.2223			0.2821	0.262			0.306	0.2989	
	0.2592	0.2185			0.286	0.2601			0.3097	0.297	
	0.2664	0.2295			0.2786	0.2484			0.302	0.285	
B1	0.2589	0.2333	18000-25000K	H1	0.2785	0.2638	10000-11500K	N1	0.3009	0.2988	6800-7500K
	0.2661	0.2443			0.2864	0.276			0.3092	0.3118	
	0.2697	0.2424			0.29	0.2742			0.313	0.3099	
	0.2629	0.2314			0.2811	0.2603			0.3047	0.2969	
B2	0.2629	0.2314		H2	0.2811	0.2603		N2	0.3047	0.2969	
	0.2697	0.2424			0.29	0.2742			0.313	0.3099	
	0.2736	0.2405			0.2939	0.2723			0.3167	0.308	
	0.2664	0.2295			0.28497	0.2584			0.3084	0.295	
D1	0.2661	0.2442	13000-18000K	J1	0.29	0.2742	8000-10000K	P1	0.3073	0.3088	6000-6800K
	0.2721	0.2538			0.2864	0.276			0.3169	0.3238	
	0.2757	0.252			0.2945	0.2888			0.3207	0.3219	
	0.2697	0.2424			0.2983	0.2869			0.3111	0.3069	
D2	0.2697	0.2424		J2	0.29	0.2742		P2	0.3111	0.3069	
	0.2757	0.252			0.2983	0.2869			0.3207	0.3219	
	0.2796	0.2501			0.302	0.285			0.3244	0.3200	
	0.2736	0.2405			0.2939	0.2723			0.3148	0.305	

THE C.I.E 1931 chromaticity diagram(Tolerance±0.01)



Forward voltage (tolerance is $\pm 0.03V@I_f=20mA$):

BIN CODE	Min.(v)	Max.(v)
6-1	2.9	3.0
6-2	3.0	3.1
7-1	3.1	3.2
7-2	3.2	3.3
8-1	3.3	3.4
8-2	3.4	3.5

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11、 Reliability test items and conditions:

No.	Test Item	Applicable Standard	Test Conditions	Sample size	Ac/Re
1	Operation Life	JESD22 A108-C	Test If=DC 20mA Temp: Room temperature Test time=1000hrs	20	0/1
2	High Temperature High Humidity	JEITA ED-4701 100 103	Temp. =+65℃ RH=90% Test time=240hrs	20	0/1
3	Thermal Shock	MIL-STD-202G	-40℃ ~+100℃ 20min 10s 20min Test Time=100 cycles	20	0/1
4	High Temperature Storage	JEITA ED-4701 200 201	High Temp. =+100℃ Test time=1000hrs	20	0/1
5	Low Temperature Storage	JEITA ED-4701 200 202	Low Ta=-40℃ Test time=1000hrs	20	0/1
6	Temperature Cycle	JEITA ED-4701 100 105	-40℃ ~+100℃ 60min 20min 60min Test Time=20cycle	20	0/1
7	Reflow Soldering	JEITA ED-4701 300 301	Operation heating: 260℃ (Max.), within 10 seconds.(Max.)	20	0/1

※Judgment criteria of failure for the reliability

Iv: Below 85% of initial values

Vf: Over 10% of upper limit value

Note:

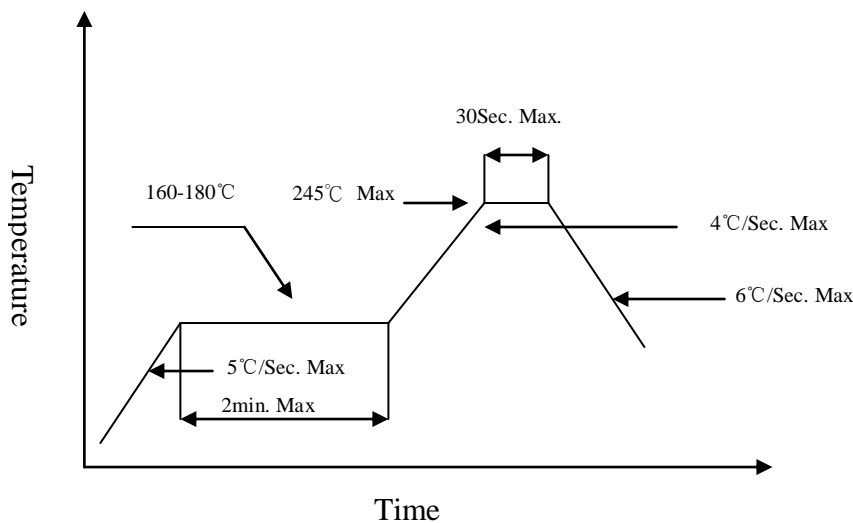
1. Measurement shall be taken within 2 hours
2. The tested LED have been returned to normal ambient conditions before testing.

12、Precautions for use :

12.1 Soldering

SMD LED encapsulation is very flexible, outside force easily demolish radiant surface and plastic, As soldering , Please handle with care !

- With No-clean Flux, according to reflow soldering cure condition when soldering, Reflow soldering should not be done more than two times, simultaneity you must insure clean on the radiant surface. Otherwise, foreign objects can affect radiant color.
- Don't process manual soldering except repair. Recommended to be soldered with 25W Anti-static iron. The temp. of the iron should be lower than 300°C and soldering time should not be done more than three seconds, at the same time iron can't touch radiant surface and plastic.
- Don't twist LED in course of manual soldering and experiment, otherwise, the lights will not work possibly.
- Please use the same BIN grade in one panel, and don't mix the difference BIN grade in one panel when soldering. Otherwise, it will cause a serious uneven color problem.
- Please control the sulfur content of solder paste and PCB.
- Pb-free solder temp.-time profile as below:245°C Max



12.2 Cleaning

- Don't be cleaned with ultrasonic. Recommended to be wiped with isopropyl alcohol or pure alcohol, wiping time should not be more than one minute. LED must be placed at room temperature for fifteen minutes before using. after cleaning, you must insure clean on the radiant surface. Otherwise, foreign objects can affect radiant color.
- LED can not be in contact with isoamyl acetate、trichloroethylene、acetone、sulfid、nitride、acid、alkali、 salt. These matter can destroy LED.

12.3 Sealing

- Sealing glue can not contain sodium ion、 sulfid, because these matter can affect fluorescence

powder poisoning.

- b. When using normal sealing glue, Recommended to be operated life for 168hrs under normal temperature.

12.4 Storage

- a. Don't open the moisture proof bag before ready to use the LEDs.
- b. The LEDs should be kept at 30°C or less and 60%RH or less before opening the package. The max. storage period before opening the package is 1 year.
- c. After opening the package, the LEDs should be kept at 30-35%RH or less, and it should be used within 3 days. If the LEDs should be kept at 30-35%RH or more, and it should be used within 4 hours.
- d. If the LEDs be kept over the conditions of 20%, baking is required before mounting. Baking condition as below: 70±5 °C for 12 hrs for bulk goods, 105±5 °C for 1 hrs for roll goods.
- e. The environment have no acid、alkali、corrosive gas、intensively shake and high magnetic field.

12.5 Static

- a. Static and Peak surge voltage can destroy LED, Avoiding Instantaneous voltage when turn on or turn off the lights.
- b. Please wear Anti-static wrist band、Anti-static glove、Anti-static shoes in the course of operation, and the equipment must be grounded.
- c. After LED is be destroyed, leakage current increase obviously, and it will be forward voltage falling or failure lamp in the case of low current.

12.6 Test

- a. Customer must apply the current limiting resistor in the circuit so as to drive the LEDs within the rated current. Otherwise slight voltage shift maybe will cause big current change and burn out will happen.
- b. Also, caution should be taken not to overload the LEDs with instantaneous high voltage at the turning ON and OFF of the circuit. Otherwise LED will be destroyed, testing methods as follows:

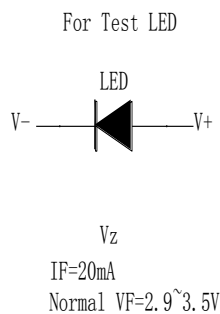


Fig.1

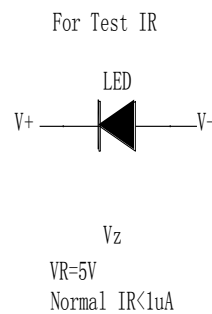


Fig.2

c. The reverse voltage mustn't exceed 5v when lighting on or testing the LED, otherwise, the LEDs will be damaged.

12.7 Else

Radiant color of LEDs have a little change with the current, recommended that LED is used in series and resistance, when lighting, please don't see directly radiant surface of LED, otherwise LED will burn eyes.